



# Product Change Notification

**Change Notification #:** 117884 - 00  
**Change Title:** Select Intel® SSD 660p Series Products, PCN 117884-00, Transport Media, Label, Package and Label Update  
**Date of Publication:** November 23, 2020

## Key Characteristics of the Change:

Transport Media, Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	December 8, 2020
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## Description of Change to the Customer:

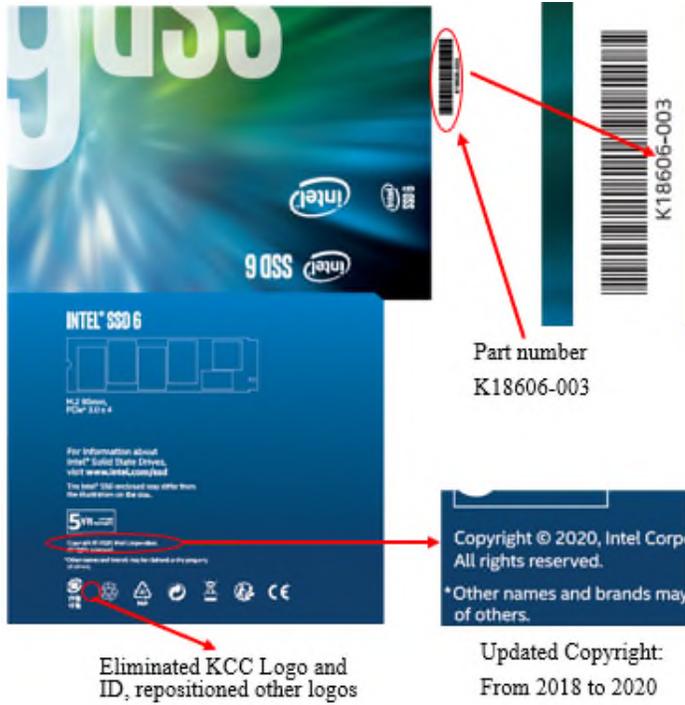
Intel® SSD 660p Series Product SKUs listed in the Products Affected table below will have the following changes:

- Change 1: Box change to eliminate KCC logo from artwork
  - Part number change from K18606-002 to K18606-003
  - Remove KCC ID Logo and move to consumer unit label
  - Change Copyright date from 2018 to 2020

### Current Artwork



## New Artwork



- Change 2: Consumer Unit Label change
  - Add KCC logo and certification I.D. to label
  - Reposition various fields to allow for space on label

### Current Label



### New Label



Added KCC Logo (6mm)  
and ID number below on  
single line

Repositioned MFG Date,  
Version number and FW  
for fit

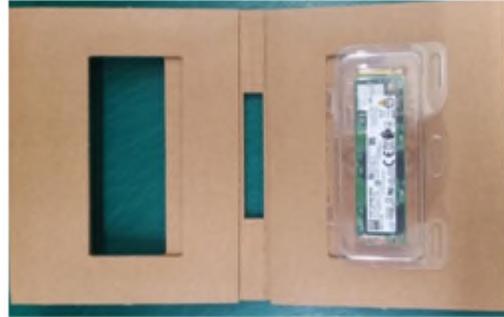
- Change 3: Structural packaging change
  - Remove corrugated "wallet" and clamshell
  - Replace with new clamshell packaging

### Current Clamshell



**Remove:** H37250-001 Clamshell

### Current Wallet



**Remove:** K29660-001 Corrugated Insert

### New Clamshell Packaging



**Replace with:** K63022-001 Tray, K63019-001 Lid, and (2) K12257-001 Tamper labels over buttons

## Customer Impact of Change and Recommended Action:

There is no change to form fit or function, nor a change to Intel Ordering codes.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD 660p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box Single Pack	SSDPEKNW512G8X1	978348
Intel® SSD 660p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box 10 Pack	SSDPEKNW512G8XT	978349
Intel® SSD 660p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box Single Pack	SSDPEKNW010T8X1	978350
Intel® SSD 660p Series (2.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box Single Pack	SSDPEKNW020T8X1	978351
Intel® SSD 660p Series (2.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box 10 Pack	SSDPEKNW020T8XT	984872
Intel® SSD 660p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box 10 Pack	SSDPEKNW010T8XT	984875
Intel® SSD 665p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D3, QLC) Retail Box Single Pack	SSDPEKNW010T9X1	999HHA
Intel® SSD 665p Series (2.0TB, M.2 80mm PCIe 3.0 x4, 3D3, QLC) Retail Box Single Pack	SSDPEKNW020T9X1	999HHG

## PCN Revision History:

**Date of Revision:**

November 23, 2020

**Revision Number:**

00

**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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